Metallized Polypropylene Film EMI Suppression Capacitors R47 Series, Class X1, 440 VAC, 110°C (Automotive Grade)



Overview

The R47 Series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material meeting the requirements of UL 94 V–0.

Automotive Grade devices are available (up to 22.5 mm Lead Spacing) and meet the demanding Automotive Electronics Council's AEC–Q200 qualification requirements.

Applications

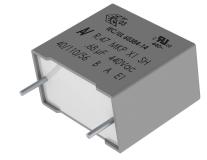
For use as a electromagnetic interference (EMI) suppression filter in across-the-line applications requiring X1 safety classification. Intended for use in situations where exposure to a shock in the event of capacitor failure is not possible. X1 classified capacitors are for use only in a permanently connected apparatus with a connection to mains which cannot be loosened without the use of a tool.

Benefits

- Approvals: ENEC, UL, cUL
- Class X1 (IEC 60384-14)
- Rated voltage: 440 VAC 50/60 Hz
- Capacitance range: 0.0047 2.2 µF
- Lead spacing: 10.0 37.5 mm
- Capacitance tolerance: ±20%, ±10%
- Climatic category: 40/110/56, IEC 60068-1
- Tape and reel in accordance with IEC 60286-2
- · RoHS Compliant and lead-free terminations
- Operating temperature range of -40°C to +110°C
- 100% screening factory test at 2,700 VDC/1,700 VAC
- Self-healing properties
- Automotive (AEC–Q200) grades available up to 22.5 mm Lead Spacing

Part Number System

R47	4		2100	00	A1	М
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
X1, Metallized Polypropylene	4 = 440	F = 10.0 I = 15.0 N = 22.5 R = 27.5 W = 37.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	A1 A2 A3	K = ±10% M = ±20%



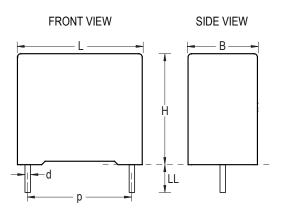


Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Ammo Pack	H ₀ = 18.5 +/-0.5	DQ
	Other Lead and Packaging Options		
10,	Tape & Reel (Large Reel)	H ₀ = 18.5 +/-0.5	СК
15,	Bulk (Bag) – Short Leads	3.5 +0.5/-0	JB
22.5	Bulk (Bag) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Bag) – Short Leads	3.2 +0.3/-0	JH
	Bulk (Bag) – Long Leads	18 +1/-1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Tape & Reel (Large Reel)	H ₀ = 18.5 +/-0.5	СК
	Other Lead and Packaging Options		
27.5	Bulk (Bag) – Short Leads	3.5 +0.5/-0	JB
	Bulk (Bag) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Bag) – Short Leads	3.2 +0.3/-0	JH
	Bulk (Bag) – Long Leads	18 +1/-1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Other Lead and Packaging Options	4 +2/-0	00
		27+05/0	
	Bulk (Bag) – Short Leads Bulk (Bag) – Short Leads	2.7 +0.5/-0	JA JB
37.5	Bulk (Bag) – Short Leads	3.5 +0.5/-0 4.0 +0.5/-0	JE
	Bulk (Bag) – Short Leads	3.2 +0.3/-0	JH
	Bulk (Bag) – Long Leads	18 +1/-1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50



Dimensions – Millimeters



I	p	E	3	I	1	I	_	d			
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance		
10.0	+/-0.4	4.0	+0.2	9.0	+0.1	13.0	+0.2	0.6	+/-0.05		
10.0	+/-0.4	5.0	+0.2	11.0	+0.1	13.0	+0.2	0.6	+/-0.05		
10.0	+/-0.4	6.0	+0.2	12.0	+0.1	13.0	+0.2	0.6	+/-0.05		
15.0	+/-0.4	5.0	+0.2	11.0	+0.1	18.0	+0.3	0.6	+/-0.05		
15.0	+/-0.4	6.0	+0.2	12.0	+0.1	18.0	+0.3	0.6	+/-0.05		
15.0	+/-0.4	6.0	+0.2	17.5	+0.1	18.0	+0.3	0.6	+/-0.05		
15.0	+/-0.4	7.5	+0.2	13.5	+0.1	18.0	+0.5	0.6	+/-0.05		
15.0	+/-0.4	7.5	+0.2	18.5	+0.1	18.0	+0.5	0.8	+/-0.05		
15.0	+/-0.4	8.5	+0.2	14.5	+0.1	18.0	+0.5	0.6	+/-0.05		
15.0	+/-0.4	9.0	+0.2	12.5	+0.1	18.0	+0.5	0.6	+/-0.05		
15.0	+/-0.4	10.0	+0.2	16.0	+0.1	18.0	+0.5	0.8	+/-0.05		
15.0	+/-0.4	11.0	+0.2	19.0	+0.1	18.0	+0.5	0.8	+/-0.05		
15.0	+/-0.4	13.0	+0.2	12.0	+0.1	18.0	+0.5	0.8	+/-0.05		
22.5	+/-0.4	6.0	+0.2	15.0	+0.1	26.5	+0.3	0.8	+/-0.05		
22.5	+/-0.4	6.5	+0.2	13,5	+0.1	26.5	+0.3	0.8	+/-0.05		
22.5	+/-0.4	7.0	+0.2	16.0	+0.1	26.5	+0.3	0.8	+/-0.05		
22.5	+/-0.4	8.5	+0.2	17.0	+0.1	26.5	+0.3	0.8	+/-0.05		
22.5	+/-0.4	10.0	+0.2	18.5	+0.1	26.5	+0.3	0.8	+/-0.05		
22.5	+/-0.4	11.0	+0.2	20.0	+0.1	26.5	+0.3	0.8	+/-0.05		
22.5	+/-0.4	13.0	+0.2	22.0	+0.1	26.5	+0.3	0.8	+/-0.05		
27.5	+/-0.4	9.0	+0.2	17.0	+0.1	32.0	+0.3	0.8	+/-0.05		
27.5	+/-0.4	11.0	+0.2	20.0	+0.1	32.0	+0.3	0.8	+/-0.05		
27.5	+/-0.4	13.0	+0.2	22.0	+0.1	32.0	+0.3	0.8	+/-0.05		
27.5	+/-0.4	14.0	+0.2	28.0	+0.1	32.0	+0.3	0.8	+/-0.05		
27.5	+/-0.4	18.0	+0.2	33.0	+0.1	32.0	+0.3	0.8	+/-0.05		
27.5	+/-0.4	22.0	+0.2	37.0	+0.1	32.0	+0.3	0.8	+/-0.05		
37.5	+/-0.4	11.0	+0.3	22.0	+0.1	41.5	+0.3	1.0	+/-0.05		
37.5	+/-0.4	13.0	+0.3	24.0	+0.1	41.5	+0.3	1.0	+/-0.05		
37.5	+/-0.4	16.0	+0.3	28.5	+0.1	41.5	+0.3	1.0	+/-0.05		
37.5	+/-0.4	19.0	+0.3	32.0	+0.1	41.5	+0.3	1.0	+/-0.05		
37.5	+/-0.4	20.0	+0.3	40.0	+0.1	41.5	+0.3	1.0	+/-0.05		
		Note: See Ordering Options Table for lead length (LL/H₀) options.									

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Performance Characteristics

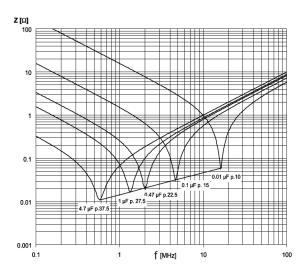
Dielectric	Polypropylene film								
Plates	Metal layer deposited by evaporation under vacuum								
Winding	Non-inductive type	Non-inductive type							
Leads	Tinned wire								
Protection	Plastic case, thermosetting	resin filled. Box material is sol	vent resistant and flame retar	dant according to UL94.					
Related documents	IEC 60384-14, EN 60384-1	4							
Rated Voltage (V_R)	440 VAC (50/60 Hz), 1,000	VDC							
Capacitance Range	0.0047 µF to 2.2 µF								
Capacitance Values	E6/E12 series (IEC 60063)								
Capacitance Tolerance	±10%, ±20%								
Temperature Range	-40°C to +110°C								
Climatic Category	40/110/56 IEC 60068-1								
Approvals	ENEC, UL, cUL								
Dissipation Factor (tanδ)	≤ 0.1% (0.06%*) at 1kHz , +	25°C ±5°C (* typical value)							
Test Voltage Between Terminals	requirements in applicable ed	test is carried out at 2,700 VDC/ quipment standards. All electrica is there is a risk to damage the c	I characteristics are checked at	fter the test. It is not					
		Measured at +25°C ±5°C,	according to IEC 60384–2						
lasulation Desistence		Minimum Values B	etween Terminals						
Insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 µF					
	100 VDC	1 min	≥ 1 • 10⁵ MΩ	≥ 30,000 MΩ • μF					
In DC Applications	Recommended voltage ≤ 1	,000 VDC							

Qualification

Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC–Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC–Q200, please visit their website at www.aecouncil.com.



Impedance Graph





Environmental Test Data

Test	IEC Publication	Procedure
Endurance	EN/IEC 60384–14	1.25 x V $_{\rm R}$ VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068–2–6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s 2
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s²
Change of Temperature	IEC 60068–2–14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384–14	V _R + 20 surge pulses at 4 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384–14	IEC 60384–1, IEC 60695–11–5 Needle flame test
Damp Heat Steady State	IEC 60068–2–78 Test Cab	+40°C and 93% RH, 56 days

Approvals

Mark	Specification	File Number	
	EN/IEC 60384-14	CA08.00101	
	UL 60384-14 and CAN/CSA E60384-14 (440 VAC)	E97797	

Environmental Compliance

All KEMET EMI capacitors are RoHS Compliant.



Table 1 – Ratings & Part Number Reference

Capacitance	Dime	ensions ir	n mm	Lead Spacing	dV/dt	New KEMET	Legacy Part Number
Value (µF)	В	Н	L	(p)	(V/µs)	Part Number	Legacy Fait Number
0.0047	4.0	9.0	13.0	10.0	750	474F1470(1)A1(2)	R474F1470(1)A1(2)
0.0068	5.0	11.0	13.0	10.0	750	474F1680(1)A1(2)	R474F1680(1)A1(2)
0.0082	6.0	12.0	13.0	10.0	750	474F1820(1)A1(2)	R474F1820(1)A1(2)
0.010	6.0	12.0	13.0	10.0	750	474F2100(1)A1(2)	R474F2100(1)A1(2)
0.010	5.0	11.0	18.0	15.0	600	474I2100(1)A1(2)	R474I2100(1)A1(2)
0.012	5.0	11.0	18.0	15.0	600	474I2120(1)A1(2)	R474I2120(1)A1(2)
0.015	5.0	11.0	18.0	15.0	600	474I2150(1)A1(2)	R474I2150(1)A1(2)
0.018	5.0	11.0	18.0	15.0	600	474I2180(1)A1(2)	R474I2180(1)A1(2)
0.022	6.0	12.0	18.0	15.0	600	474I2220(1)A1(2)	R474I2220(1)A1(2)
0.027	6.0	12.0	18.0	15.0	600	474I2270(1)A1(2)	R474I2270(1)A1(2)
0.033	6.0	12.0	18.0	15.0	600	474I2330(1)A1(2)	R474I2330(1)A1(2)
0.039	7.5	13.5	18.0	15.0	600	474I2390(1)A1(2)	R474I2390(1)A1(2)
0.047	7.5	13.5	18.0	15.0	600	474I2470(1)A1(2)	R474I2470(1)A1(2)
0.047	6.0	17.5	18.0	15.0	600	474I2470(1)A2(2)	R474I2470(1)A2(2)
0.047	9.0	12.5	18.0	15.0	600	474I2470(1)A3(2)	R474I2470(1)A3(2)
0.056	8.5	14.5	18.0	15.0	600	474I2560(1)A1(2)	R474I2560(1)A1(2)
0.068	10.0	16.0	18.0	15.0	600	474I2680(1)A1(2)	R474I2680(1)A1(2)
0.068	7.5	18.5	18.0	15.0	600	474I2680(1)A2(2)	R474I2680(1)A2(2)
0.068	13.0	12.0	18.0	15.0	600	47412680(1)A3(2)	R474I2680(1)A3(2)
0.082	10.0	16.0	18.0	15.0	600	47412820(1)A1(2)	R474I2820(1)A1(2)
0.10	11.0	19.0	18.0	15.0	600	474I3100(1)A1(2)	R474I3100(1)A1(2)
0.047	6.0	15.0	26.5	22.5	300	474N2470(1)A1(2)	R474N2470(1)A1(2)
0.047	6.5	13.5	26.5	22.5	300	474N2470(1)A2(2)	R474N2470(1)A2(2)
0.068	6.0	15.0	26.5	22.5	300	474N2680(1)A1(2)	R474N2680(1)A1(2)
0.10	7.0	16.0	26.5	22.5	300	474N3100(1)A1(2)	R474N3100(1)A1(2)
0.12	8.5	17.0	26.5	22.5	300	474N3120(1)A1(2)	R474N3120(1)A1(2)
0.15	10.0	18.5	26.5	22.5	300	474N3150(1)A1(2)	R474N3150(1)A1(2)
0.18	10.0	18.5	26.5	22.5	300	474N3180(1)A1(2)	R474N3180(1)A1(2)
0.22	11.0	20.0	26.5	22.5	300	474N3220(1)A1(2)	R474N3220(1)A1(2)
0.27	13.0	22.0	26.5	22.5	300 300	474N3270(1)A1(2)	R474N3270(1)A1(2)
0.33	13.0 9.0	22.0	26.5	22.5 27.5	225	474N3330(1)A1(2)	R474N3330(1)A1(2)
0.15 0.18	9.0	17.0 17.0	32.0 32.0	27.5	225	474R3150(1)A1(2)	R474R3150(1)A1(2)
0.18	9.0	17.0	32.0	27.5	225	474R3180(1)A1(2)	R474R3180(1)A1(2)
0.22	9.0	17.0	32.0	27.5	225	474R3220(1)A1(2) 474R3270(1)A2(2)	R474R3220(1)A1(2) R474R3270(1)A2(2)
0.33	9.0	20.0	32.0	27.5	225	474R3330(1)A2(2)	R474R3270(1)A2(2)
0.39	11.0	20.0	32.0	27.5	225	474R3390(1)A1(2)	R474R3390(1)A1(2)
0.39	13.0	20.0	32.0	27.5	225	474R3390(1)A1(2) 474R3470(1)A1(2)	R474R3390(1)A1(2)
0.47	13.0	22.0	32.0	27.5	225	474R3560(1)A1(2)	R474R3470(1)A1(2)
0.68	14.0	22.0	32.0	27.5	225	474R3680(1)A1(2)	R474R3680(1)A1(2)
0.82	14.0	33.0	32.0	27.5	225	474R3820(1)A1(2)	R474R3820(1)A1(2)
1.0	18.0	33.0	32.0	27.5	225	474R4100(1)A1(2)	R474R4100(1)A1(2)
1.0	18.0	33.0	32.0	27.5	225	474R4120(1)A1(2)	R474R4120(1)A1(2)
1.5	22.0	37.0	32.0	27.5	225	474R4150(1)A1(2)	R474R4150(1)A1(2)
0.47	11.0	22.0	41.5	37.5	150	474W3470(1)A1(2)	R474W3470(1)A1(2)
0.56	11.0	22.0	41.5	37.5	150	474W3560(1)A1(2)	R474W3560(1)A1(2)
0.68	13.0	24.0	41.5	37.5	150	474W3680(1)A1(2)	R474W3680(1)A1(2)
0.82	16.0	28.5	41.5	37.5	150	474W3820(1)A1(2)	R474W3820(1)A1(2)
1.0	16.0	28.5	41.5	37.5	150	474W4100(1)A1(2)	R474W4100(1)A1(2)
1.2	19.0	32.0	41.5	37.5	150	474W4120(1)A1(2)	R474W4120(1)A1(2)
1.5	19.0	32.0	41.5	37.5	150	474W4150(1)A1(2)	R474W4150(1)A1(2)
1.8	20.0	40.0	41.5	37.5	150	474W4180(1)A1(2)	R474W4180(1)A1(2)
2.2	20.0	40.0	41.5	37.5	150	474W4220(1)A1(2)	R474W4220(1)A1(2)
Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	dV/dt (V/µs)	New KEMET Part Number	Legacy Part Number

(1) Insert lead and packaging code. See Ordering Options Table for available options.

(2) $M = \pm 20\%$, $K = \pm 10\%$



Soldering Process

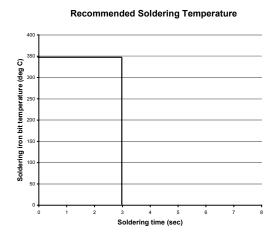
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 - 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 - 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert throughhole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

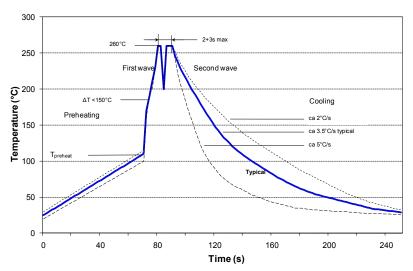
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont'd

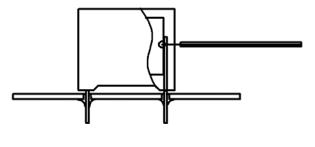
Wave Soldering Recommendations cont'd

1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric Film Material		imum Pre emperatu	Maximum Peak Soldering Temperature		
	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

The maximum temperature measured inside the capacitor: Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene sulphide	160°C



Temperature monitored inside the capacitor.

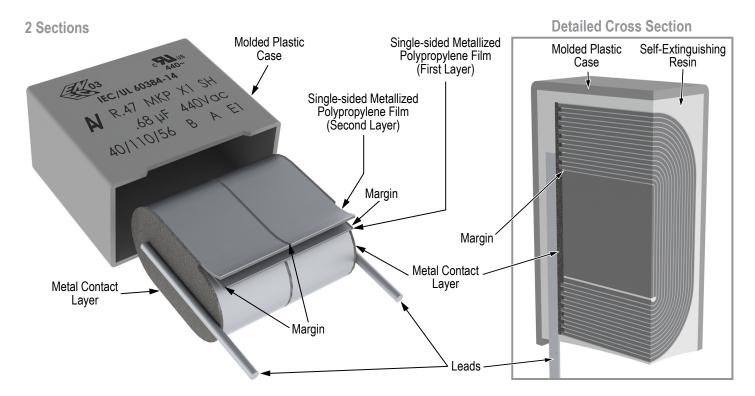
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

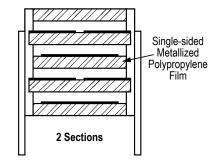
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, however, instead of two baths, there is only one bath with a time from 3 to 10 seconds. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



Construction



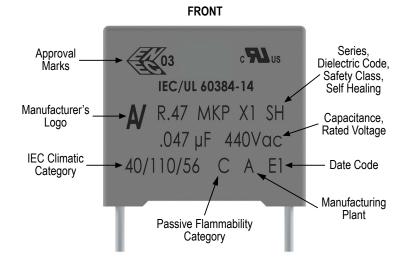
Winding Scheme

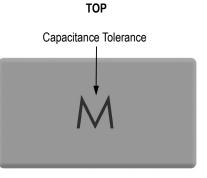


Electronic Components

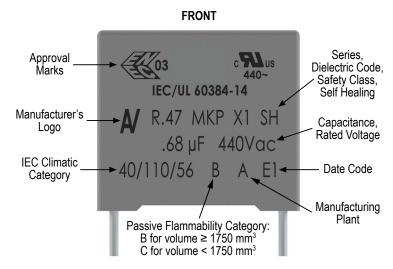
Marking

Lead Spacing 10 mm

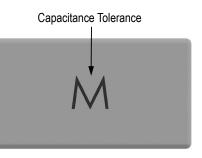




Lead Spacing 15 mm, 22.5 mm (small case sizes)



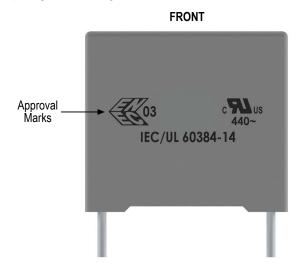
TOP



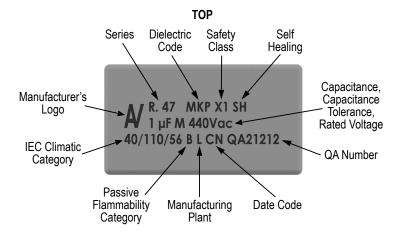


Marking cont'd

Lead Spacing 22.5 mm (large case sizes), 27.5 mm, 37.5 mm



Ma	Manufacturing Date Code (IEC 60062)								
Y = Year, Z = Month									
Year	Code	Month	Code						
2000	М	January	1						
2001	N	February	2						
2002	Р	March	3						
2003	R	April	4						
2004	S	Мау	5						
2005	Т	June	6						
2006	U	July	7						
2007	V	August	8						
2008	W	September	9						
2009	Х	October	0						
2010	А	November	N						
2011	В	December	D						
2012	С								
2013	D								
2014	E								
2015	F								
2016	Н								
2017	J								
2018	К								
2019	L								
2020	М								





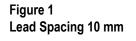
Packaging Quantities

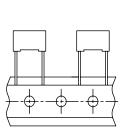
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped
	4.0	9.0	13.0	2000	1800	750	1500	1000
10	5.0	11.0	13.0	1300	1500	600	1250	800
	6.0	12.0	13.0	1000	1200	500	1000	680
	5.0	11.0	18.0	2000	1000	600	1250	800
	6.0	12.0	18.0	1750	900	500	1230	680
	6.0	17.5	18.0	1000	700	500	1000	680
	7.5	13.5	18.0	1000	700	350	800	500
	7.5	18.5	18.0	900	500	550	800	500
15	8.5	14.5	18.0	1000	500	300	700	440
	9.0	14.5	18.0	1000	520	270	650	410
	10.0	16.0	18.0	750	520	300	600	380
	11.0	19.0	18.0	450	350	_	500	340
	13.0	13.0	18.0	750	490	200	480	280
	10.0	12.0	10.0	100	400	200	400	200
	6.0	15.0	26.5	805	500	-	700	464
	6.5	13.5	26.5	800	-	-	-	-
	7.0	16.0	26.5	700	500	-	550	380
22.5	8.5	17.0	26.5	468	300	-	450	280
	10.0	18.5	26.5	396	300	_	350	235
	11.0	20.0	26.5	360	250	-	350	217
	13.0	22.0	26.5	300	200	_	300	-
	9.0	17.0	32.0	816	408		450	
					336	_		_
	11.0 13.0	20.0	32.0	560 480	288	_	350	_
07.5		22.0	32.0	352	288 176	_	300	_
27.5	14.0 18.0	28.0 33.0	32.0 32.0	256	176	_	-	_
	22.0		32.0	168	120	_		_
		37.0				_		_
	22.0	37.0	32.0	168	112	-	_	_
	11.0	22.0	41.5	420	252	-	-	-
	13.0	24.0	41.5	360	216	-	-	-
37.5	16.0	28.5	41.5	216	108	-	-	-
	19.0	32.0	41.5	192	96	_	_	_
	20.0	40.0	41.5	126	84	-	-	-



Lead Taping & Packaging (IEC 60286-2)

Figure 2





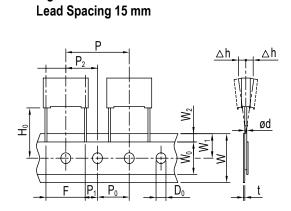
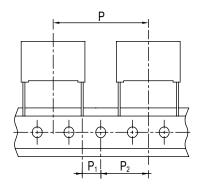


Figure 3 Lead Spacing 22.5 – 27.5 mm



Taping Specification

		Dimensions (mm)					
Description	Symbol						
Description	Cymbol	10	15	22.5	27.5	Tol.	
		Fig. 1	Fig. 2	Fig. 3	Fig. 3		
Lead wire diameter	d	0.6	0.6-0.8	0.8	0.8	±0.05	
Taping lead space	Р	25.4	25.4	38.1	38.1	±1	
Feed hole lead space *	P ₀	12.7	12.7	12.7	12.7	±0.2 **	
Centering of the lead wire	P ₁	7.7	5.2	7.8	5.3	±0.7	
Centering of the body	P ₂	12.7	12.7	19.05	19.05	±1.3	
Lead spacing (pitch) ***	F	10	15	22.5	27.5	+0.6/-0.1	
Component alignment	Δh	0	0	0	0	±2	
Height of component from tape center	H ₀ ****	18.5	18.5	18.5	18.5	±0.5	
Carrier tape width	W	18	18	18	18	+1 / -0.5	
Hold down tape width	W ₀	9	10	10	10	Minimum	
Hole position	W ₁	9	9	9	9	±0.5	
Hold down tape position	W ₂	3	3	3	3	Maximum	
Feed hole diameter	D ₀	4	4	4	4	±0.2	
Tape thickness	t	0.7	0.7	0.7	0.7	±0.2	

* Also available in 15 mm.

** Max 1 mm on 20 lead spaces.

*** Pitches 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request.

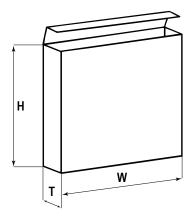
**** H_0 = 16.5 mm available upon request.



Lead Taping & Packaging (IEC 60286-2) cont'd

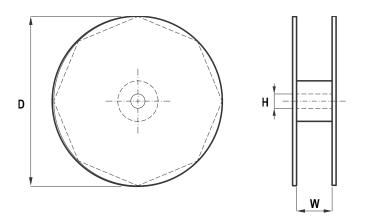
Ammo Specifications

Dimensions (mm)				
Н	W	т		
360	340	59		



Reel Specifications

Reel Size	Dimensions (mm)		
	D	Н	W
Standard	355	30	55 Maximum
Large	500	25	





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